18mm (0.7 INCH) SINGLE COLOR DOT MATRIX DISPLAY

Part Number: TC07-11GWA    Green

Features
- 0.7 inch matrix height.
- Dot size 2mm.
- Low current operation.
- Stackable vertically and horizontally.
- Easy mounting on P.C. boards or sockets.
- Mechanically rugged.
- Standard: gray face, white dot.
- RoHS compliant.

Description
The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Notes:
1. All dimensions are in millimeters (inches). Tolerance is ±0.25(0.01") unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
### Selection Guide

<table>
<thead>
<tr>
<th>Part No.</th>
<th>Dice</th>
<th>Lens Type</th>
<th>( I_v) [ucd] (^{[1]}) @ 10mA</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>TC07-11GWA</td>
<td>Green (GaP)</td>
<td>White Diffused</td>
<td>5600 12000 *1400 *3500</td>
<td>Column Cathode</td>
</tr>
</tbody>
</table>

Notes:
1. Luminous intensity/ luminous Flux: +/-15%.
   *Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at \( TA=25°C \)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Device</th>
<th>Typ.</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>( \lambda ) peak</td>
<td>Peak Wavelength</td>
<td>Green</td>
<td>565</td>
<td>nm</td>
<td></td>
<td>( I_r=20mA )</td>
</tr>
<tr>
<td>( \Delta \lambda ) [1]</td>
<td>Dominant Wavelength</td>
<td>Green</td>
<td>568</td>
<td>nm</td>
<td></td>
<td>( I_r=20mA )</td>
</tr>
<tr>
<td>( \Delta \lambda ) [1/2]</td>
<td>Spectral Line Half-width</td>
<td>Green</td>
<td>30</td>
<td>nm</td>
<td></td>
<td>( I_r=20mA )</td>
</tr>
<tr>
<td>C</td>
<td>Capacitance</td>
<td>Green</td>
<td>15</td>
<td>pF</td>
<td>VF=0V;f=1MHz</td>
<td></td>
</tr>
<tr>
<td>VF [2]</td>
<td>Forward Voltage</td>
<td>Green</td>
<td>2.2</td>
<td>2.5</td>
<td>V</td>
<td>( I_r=20mA )</td>
</tr>
<tr>
<td>IR</td>
<td>Reverse Current</td>
<td>Green</td>
<td>10</td>
<td>uA</td>
<td>VR=5V</td>
<td></td>
</tr>
</tbody>
</table>

Notes:
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

### Absolute Maximum Ratings at \( TA=25°C \)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Green</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Power dissipation</td>
<td>62.5</td>
<td>mW</td>
</tr>
<tr>
<td>DC Forward Current</td>
<td>25</td>
<td>mA</td>
</tr>
<tr>
<td>Peak Forward Current [1]</td>
<td>140</td>
<td>mA</td>
</tr>
<tr>
<td>Reverse Voltage</td>
<td>5</td>
<td>V</td>
</tr>
<tr>
<td>Operating / Storage Temperature</td>
<td>-40°C To +85°C</td>
<td></td>
</tr>
<tr>
<td>Lead Solder Temperature[2]</td>
<td>260°C For 3-5 Seconds</td>
<td></td>
</tr>
</tbody>
</table>

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
Green TC07-11GWA

Relative Radiant Intensity

\[ \text{wavelength } \lambda \text{ (nm)} \]

RELATIVE INTENSITY Vs. WAVELENGTH

\[ T_a = 25^\circ C \]

Forward Current (mA)

Forward Voltage (V)

Forward Current Vs. FORWARD VOLTAGE

Luminous Intensity

Relative Value of \( I = 10 \text{mA} \)

LUMINOUS INTENSITY Vs. FORWARD CURRENT

Forward Current (mA)

Ambient Temperature \( T_a \) (°C)

FORWARD CURRENT DERATING CURVE

Relative Luminous Intensity

Ambient Temperature \( T_a \) (°C)

LUMINOUS INTENSITY Vs. AMBIENT TEMPERATURE
PACKING & LABEL SPECIFICATIONS

Inside Label on IC-TUBE

Outside Label on Box

28PCS/TUBE

INSIDE LABEL

OUTSIDE LABEL

5040PCS/BOX

180TUBE/BOX

Inside Label On IC-TUBE

Outside Label On Box

XXXXXX

Tx07-11xxx

5040 PCS

Bin Code

Number of QA

Date

Number of FQC

Date

RoHS Compliant

RoHS Compliant

XXX XXXXXX-XXX

QTY: 28 PCS  CODE: xx

Wrong

PASSED
THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming
Do not bend the component leads by hand without proper tools.
The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

Installation
1. The installation process should not apply stress to the lead terminals.
2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.
3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.
DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead–free Through–hole LED.

NOTES:
1. Recommend the wave temperature 245°C~280°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering, the PCB top-surface temperature should be kept below 105°C.
5. No more than once.

Soldering General Notes:
1. Through–hole displays are incompatible with reflow soldering.
2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING
1. Mild "no–clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts. And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES
1. Protective current–limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current–limiting resistor.

Detailed application notes are listed on our website.
http://www.kingbright.com/application_notes